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FDN5630

60V N-Channel PowerTrench® MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

This MOSFET features very low R_{DS(ON)} in a small SOT23 footprint. ON Semiconductor's PowerTrench technology provides faster switching than other MOSFETs with comparable R_{DS(ON)} specifications. The result is higher overall efficiency with less board space.

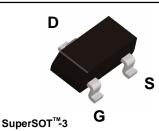
• 1.7 A, 60 V. $\mathrm{R}_{\mathrm{DS(ON)}}$ = 0.100 Ω @ V_{GS} = 10 V

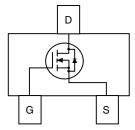
Features

- $R_{DS(ON)} = 0.120 \ \Omega \ @ V_{GS} = 6 \ V.$
- Optimized for use in high frequency DC/DC converters.
- Low gate charge.
- Very fast switching.
- SuperSOT[™] 3 provides low R_{DS(ON)} in SOT23 footprint.

Applications

- DC/DC converter
- Motor drives





Absolute Maximum Ratings T_A = 25 C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		60	V
V _{GSS}	Gate-Source Voltage		±20	V
ID	Drain Current - Continuous	(Note 1a)	1.7	A
	- Pulsed		10	
P _D	Power Dissipation for Single Operation	(Note 1a)	0.5	W
		(Note 1b)	0.46	
TJ, T _{stg}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

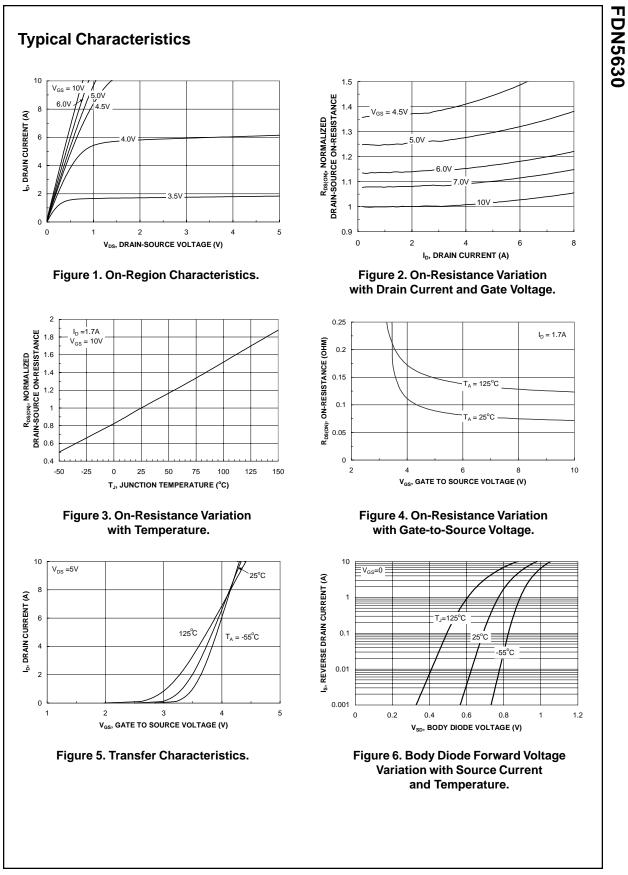
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	250	°C/W
$R_{_{\!\!\!\!\!\Theta}JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	75	°C/W

Package Marking and Ordering Information

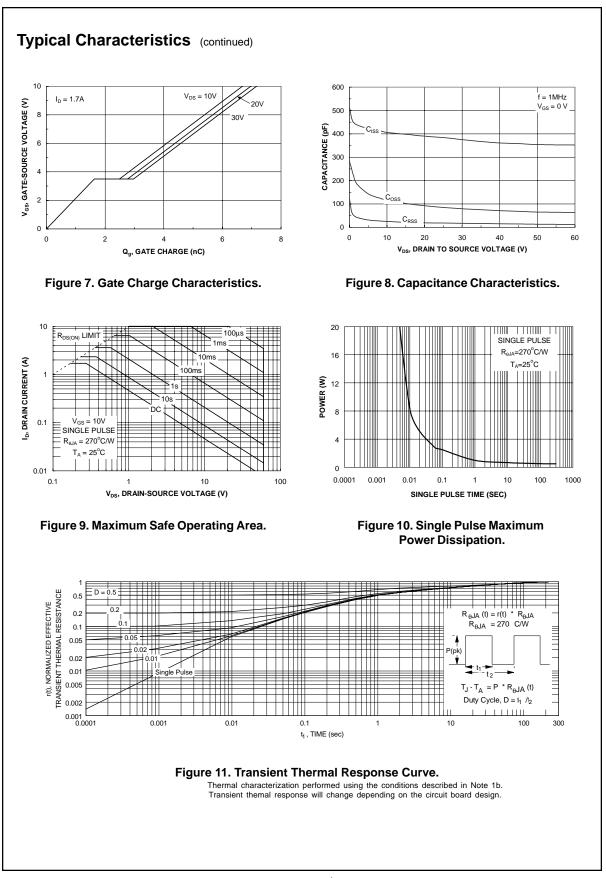
Device Marking	Device	Reel Size	Tape Width	Quantity
5630	FDN5630	7	8mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	60			V
<u>ΔBV_{DSS}</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}, \text{Referenced to } 25^\circ\text{C}$		63		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 V, V_{DS} = 0 V$			-100	nA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1	2.4	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}, \text{Referenced to } 25^\circ\text{C}$		-6.9		mV/°C
R _{DS(ON)}	Static Drain-Source On-Resistance	$ \begin{array}{l} V_{GS} = 10 \; V, \; I_D = 1.7 \; A \\ V_{GS} = 10 \; V, \; I_D = 1.7 \; A, \; T_J = 125^\circ C \\ V_{GS} = 6 \; V, \; I_D = 1.6 \; A \end{array} $		0.073 0.127 0.083	0.100 0.180 0.120	Ω
I _{D(on)}	On-State Drain Current	V _{GS} = 10 V, V _{DS} = 1.7 V	5			A
g fs	Forward Transconductance	V _{DS} = 10 V, I _D = 1.7 A		6		S
Dynamic	Characteristics	·	4			
C _{iss}	Input Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V,$	1	400	560	pF
	Output Capacitance	f = 1.0 MHz		65	95	pF
	Reverse Transfer Capacitance			27	40	pF
				21	70	<u> </u>
	g Characteristics (Note 2) Turn-On Delay Time	V _{DD} = 30 V, I _D = 1 A,	1	10	20	- ne
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 30 \text{ V}, \text{ I}_D = 1 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		6		ns
t _r	Turn-Off Delay Time			15	15 28	ns
t _{d(off)}	Turn-Off Delay Time	4		-	-	ns
t _f				5	15	ns
Q _g	Total Gate Charge	$V_{DS} = 20 \text{ V}, I_D = 1.7 \text{ A},$ $V_{GS} = 10 \text{ V},$			10	nC
Q _{gs}	Gate-Source Charge	-		1.6		nC
Q _{gd}	Gate-Drain Charge			1.2		nC
-	urce Diode Characteristics a		.	.		
ls	Maximum Continuous Drain-Source				0.42	A
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = 0.42 A$ (Note 2)		0.72	1.2	V
Scale 1 : 1 c	ain pins. $R_{_{\!RJC}}$ is guaranteed by design while $R_{_{\!RJA}}$ is d $$\!$	al resistance where the case thermal reference is defi determined by the user's board design. b) 270°C/W when mounted on a minimum pad.	ined as the	∍solder mour	ıting	

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